

# TrenchT2<sup>™</sup> HiperFET **Power MOSFET**

# **IXFA110N15T2** IXFP110N15T2

N-Channel Enhancement Mode Avalanche Rated



g.	
8-14	

٩D	

(IXFA)	G S D (Tab)
TO-220	

150V

110A

 $13m\Omega$ 

TO-220 (IXFP)	
	GDS D (Tab)

G = Gate	D	= Drain
S = Source	Tab	= Drain

Symbol	Test Conditions	Maximum	Ratings
V <sub>DSS</sub>	$T_{_{\rm J}}$ = 25°C to 175°C	150	V
$V_{DGR}$	$T_J = 25^{\circ}C$ to 175°C, $R_{GS} = 1M\Omega$	150	V
V <sub>GSS</sub>	Continuous	± 20	V
V <sub>GSM</sub>	Transient	± 30	V
I <sub>D25</sub>	$T_c = 25^{\circ}C$	110	Α
I <sub>DM</sub>	$T_{c} = 25^{\circ}C$ , Pulse Width Limited by $T_{JM}$	300	Α
I <sub>A</sub>	$T_c = 25^{\circ}C$	50	А
E <sub>AS</sub>	T <sub>c</sub> = 25°C	800	mJ
dV/dt	$I_{_{S}} \le I_{_{DM}}, V_{_{DD}} \le V_{_{DSS}}, T_{_{J}} \le 175^{\circ}C$	15	V/ns
P <sub>D</sub>	T <sub>C</sub> = 25°C	480	W
T <sub>J</sub>		-55 +175	°C
T <sub>JM</sub>		175	°C
T <sub>stg</sub>		-55 +175	°C
T <sub>L</sub>	Maximum Lead Temperature for Soldering	g 300	°C
T <sub>SOLD</sub>	1.6 mm (0.062in.) from Case for 10s	260	°C
F <sub>c</sub>	Mounting Force (TO-263) Mounting Torque (TO-220)	1065 / 2.214.6 1.13 / 10	N/lb Nm/lb.in
Weight	TO-263 TO-220	2.5 3.0	g g

SymbolTest ConditionsChara $(T_J = 25^{\circ}C)$ unless otherwise specified)Min.			cteristic Typ.	c Value   Max.	
BV <sub>DSS</sub>	$V_{GS} = 0V$ , $I_D = 250\mu A$	150			V
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5		4.5	V
I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}, V_{GS} = 0V$			5	μА
	$T_J = 150$ °C			150	μΑ
R <sub>DS(on)</sub>	$V_{GS} = 10V$ , $I_D = 0.5 \bullet I_{D25}$ , Notes 1, 2		11	13	mΩ

### **Features**

D<sub>25</sub>

 $R_{DS(on)}$ 

TO-263

- International standard packages
- 175°C Operating Temperature
- High current handling capability
- Fast intrinsic Rectifier
- Dynamic dV/dt rated
- Low R<sub>DS(on)</sub>

### **Advantages**

- Easy to mount
- Space savings
- High power density

#### **Applications**

- DC-DC converters
- Battery chargers
- Switched-mode and resonant-mode power supplies
- DC choppers
- AC motor drives
- Uninterruptible power supplies
- High speed power switching applications



SymbolTest ConditionsCharacter $(T_1 = 25^{\circ}C, unless otherwise specified)$ Min.		cteristic	Values Max.		
g <sub>fs</sub>		$V_{DS} = 10V, I_{D} = 55A, \text{ Note 1}$	75	115	S
C <sub>iss</sub>	)			8600	pF
C <sub>oss</sub>	}	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		685	pF
C <sub>rss</sub>	J			77	pF
t <sub>d(on)</sub>	١	Parietics Coultables Times		33	ns
t <sub>r</sub>		Resistive Switching Times $V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D2S}$		16	ns
t <sub>d(off)</sub>		$R_{\rm G} = 3.3\Omega$ (External)		33	ns
t <sub>f</sub>	J	G , ,		18	ns
Q <sub>g(on)</sub>	)			150	nC
Q <sub>gs</sub>	}	$V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25}$		42	nC
$Q_{gd}$	J			46	nC
R <sub>thJC</sub>					0.31 °C/W
R <sub>thCH</sub>		TO-220		0.50	°C/W

#### Source-Drain Diode

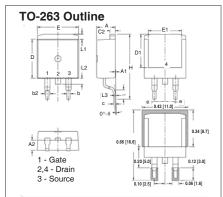
Symbol Test Conditions Character			acteristic	<b>Values</b>	
$(T_{J} = 25)$	5°C, unless otherwise specified)	Min.	Тур.	Max.	
Is	$V_{GS} = 0V$			110	Α
I <sub>SM</sub>	Repetitive, Pulse width limited by $\rm T_{_{\rm JM}}$			440	Α
V <sub>SD</sub>	$I_F = 100A, V_{GS} = 0V, Note 1$			1.3	V
t <sub>rr</sub>	$I_{\rm F} = 55A, V_{\rm GS} = 0V$		85		ns
I <sub>RM</sub>	-di/dt = 100A/μs		6.8		Α
$\mathbf{Q}_{RM}$	$\int V_R = 75V$		290		nC

Notes: 1. Pulse test,  $t \le 300\mu s$ ; duty cycle,  $d \le 2\%$ .

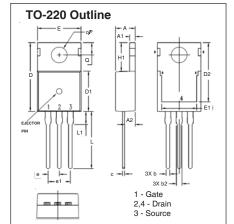
2. On through-hole packages, R<sub>DS(on)</sub> Kelvin test contact location must be 5mm or less from the package body.

## PRELIMINARY TECHNICAL INFORMATION

The product presented herein is under development. The Technical Specifications offered are derived from data gathered during objective characterizations of preliminary engineering lots; but also may yet contain some information supplied during a pre-production design evaluation. IXYS reserves the right to change limits, test conditions, and dimensions without notice.



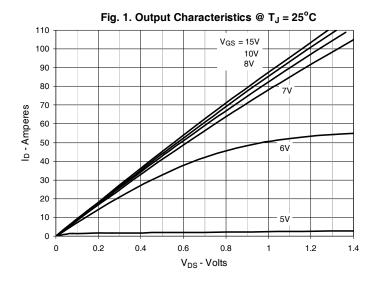
SYM	INCHES MILLIMETER			METER
SIM	MIN	MAX	MIN	MAX
Α	.170	.185	4.30	4.70
A1	.000	.008	0.00	0.20
A2	.091	.098	2.30	2.50
Ь	.028	.035	0.70	0.90
b2	.046	.060	1.18	1.52
С	.018	.024	0.45	0.60
C2	.049	.060	1.25	1.52
D	.340	.370	8.63	9.40
D1	.300	.327	7.62	8.30
E	.380	.410	9.65	10.41
E1	.270	.330	6.86	8.38
е	.100	BSC	2.54	BSC
Н	.580	.620	14.73	15.75
L	.075	.105	1.91	2.67
L1	.039	.060	1.00	1.52
L2	_	.070	_	1.77
L3	.010	BSC	0.254 BSC	

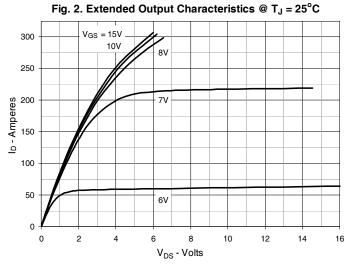


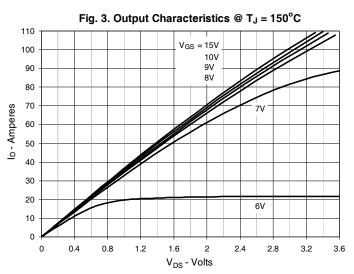
MYZ	INCHES MILLIMETER			ETERS
2114	MIN	MAX	MIN	MAX
Α	.169	.185	4.30	4.70
A1	.047	.055	1.20	1.40
A2	.079	.106	2.00	2.70
Ь	.024	.039	0.60	1.00
b2	.045	.057	1.15	1.45
С	.014	.026	0.35	0.65
D	.587	.626	14.90	15.90
D1	.335	.370	8.50	9.40
(D2)	.500	.531	12.70	13.50
Ε	.382	.406	9.70	10.30
(E1)	.283	.323	7.20	8.20
е	.100 BSC		2.54	BSC
e1	.200	BSC	5.08	BSC
H1	.244	.268	6.20	6.80
Ĺ	.492	.547	12.50	13.90
L1	.110	.154	2.80	3.90
ØΡ	.134	.150	3.40	3.80
Q	.106	.126	2.70	3.20

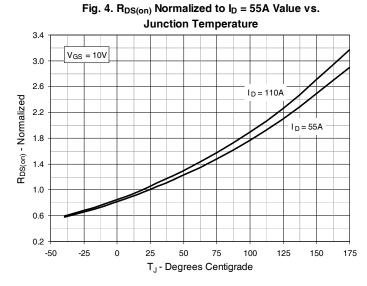
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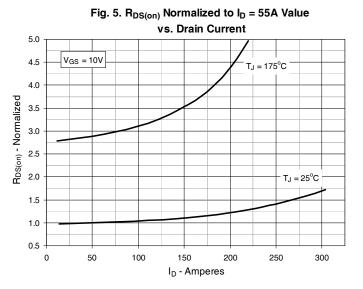


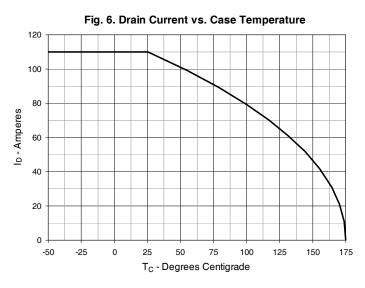




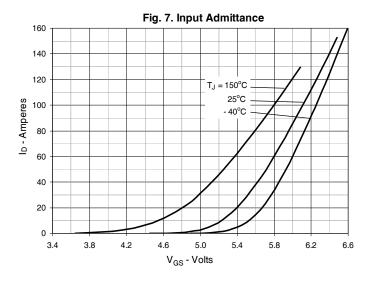


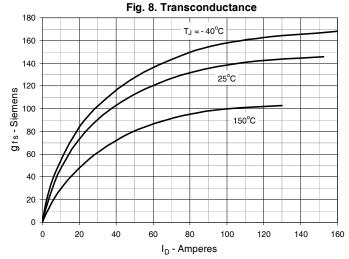


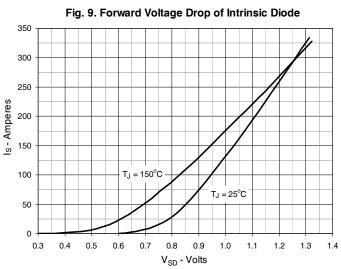


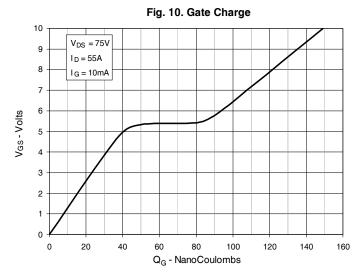


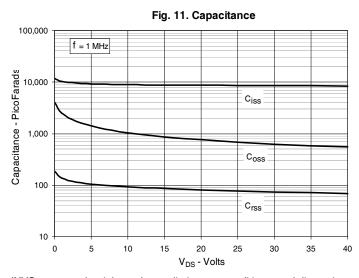


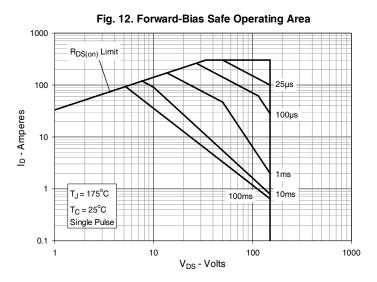












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Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

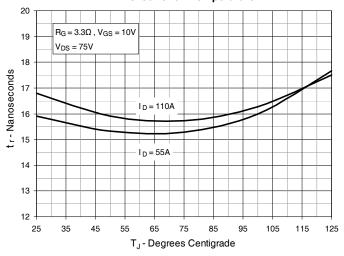


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

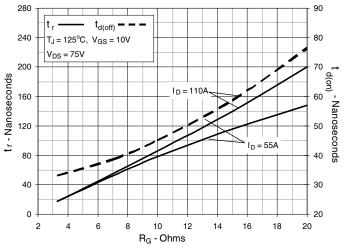


Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

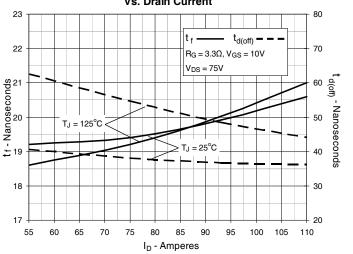


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

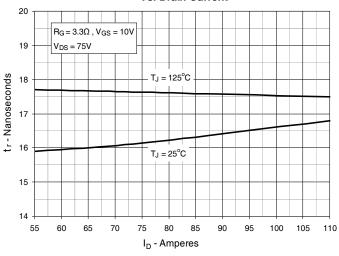


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

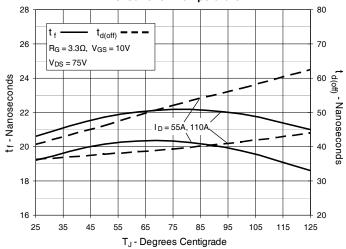
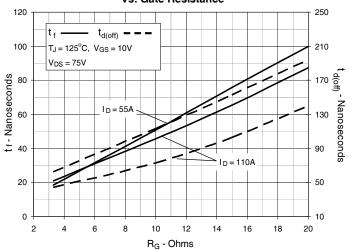
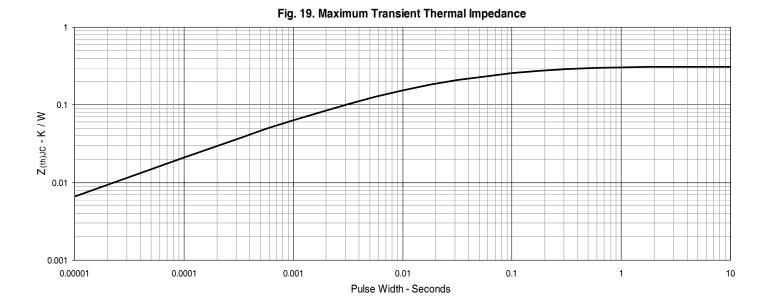


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance







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